

SCHS380 A -JUNE 2010-REVISED AUGUST 2011

# CMOS QUAD LOW-TO-HIGH VOLTAGE SHIFTER

Check for Samples: CD40109B-Q1

# **FEATURES**

- Qualified for Automotive Applications
- Independent of Power Supply Sequence Considerations
  - V<sub>CC</sub> Can Exceed V<sub>DD</sub>
  - Input Signals can Exceed Both  $V_{CC}$  and  $V_{DD}$
- Up and Down Level-Shifting Capability
- Three-State Outputs With Separate Enable Controls
- Standardized Symmetrical Output Characteristics
- 100% Tested for Quiescent Current at 20 V
- Maximum Input Current:
  - 1 µA at 18 V Over Full Package-Temperature Range
  - 100 nA at 18 V and 25°C
- Noise Margin (Full Package-Temperature Range):
  - 1 V at V<sub>CC</sub> = 5 V, V<sub>DD</sub> = 10 V
  - 2 V at V<sub>CC</sub> = 10 V, V<sub>DD</sub> = 15 V
- 5-V, 10-V, and 15-V Parametric Ratings
- Meets All Requirements of JEDEC Tentative Standard No. 13B, "Standard specifications for

# DESCRIPTION

CD40109B contains four low-to-high-voltage level-shifting circuits. Each circuit will shift a low-voltage digital-logic input signal (A, B, C, D) with logical  $1 = V_{CC}$  and logical  $0 = V_{SS}$  to a high-voltage output signal (E, F, G, H) with logical  $1 = V_{DD}$  and logical  $0 = V_{SS}$ .

The RCA-CD40109, unlike other low-to-high level-shifting circuits, does not require the presence of the high-voltage supply ( $V_{DD}$ ) before the application of either the low-voltage supply ( $V_{CC}$ ) or the input signals. There are no restrictions on the sequence of application of  $V_{DD}$ ,  $V_{CC}$ , or the input signals. In addition, with one exception there are no restrictions on the relative magnitudes of the supply voltages or input signals within the device maximum ratings, provided that the input signal swings between  $V_{SS}$  and at least 0.7  $V_{CC}$ ;  $V_{CC}$  may exceed  $V_{DD}$ , and input signals may exceed  $V_{CC}$  and  $V_{DD}$ . When operated in the mode  $V_{CC} > V_{DD}$ , the CD40109 will operate as a high-to-low level-shifter.

The CD40109 also features individual three-state output capability. A low level on any of the separately enabled three-state output controls produces a high-impedance state in the corresponding output.

### ORDERING INFORMATION<sup>(1)</sup>

| T <sub>A</sub> | PACK      | AGE <sup>(2)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|--------------------|-----------------------|------------------|
| –40°C to 125°C | SOIC – NS | Reel of 2000       | CD40109BQNSRQ1        | CD40109BQ        |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



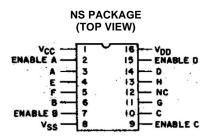
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Description of 'B' Series CMOS Devices"

 Latch-Up Performance Meets 50 mA per JESD 78, Class I

## APPLICATIONS

- High-or-Low Level-Shifting With Three-State Outputs for Unidirectional or Bidirectional Bussing
- Isolation of Logic Subsystem Using Separate Power Supplies from Supply Sequencing, Supply Loss, and Supply Regulation Considerations



# CD40109B-Q1



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

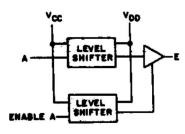
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## TRUTH TABLE<sup>(1)</sup>

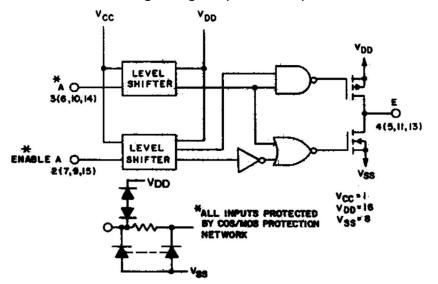
| INP        | OUTPUTS              |            |
|------------|----------------------|------------|
| A, B, C, D | ENABLE<br>A, B, C, D | E, F, G, H |
| 0          | 1                    | 0          |
| 1          | 1                    | 1          |
| Х          | 0                    | Z          |

(1) 0 = V\_{SS}, 1 = V\_{CC} at inputs and  $V_{DD}$  at outputs, X = Don't care, Z = High impedance

#### Functional Diagram (1 of 4 Units)



Logic Diagram (1 of 4 Units)





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### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| over operating free-air | temperature range | (unless otherwise noted) |
|-------------------------|-------------------|--------------------------|
|                         |                   |                          |

|                  |  |   | VALUE                                    | UNIT |
|------------------|--|---|--|------|
| $V_{DD}$         | DC supply voltage range  | Voltages referenced to V <sub>SS</sub> terminal   | -0.5 to +20                              | V    |
|                  | Output voltage range   | All outputs                                       | –0.5 to V <sub>DD</sub> + 0.5            | V    |
|                  | DC input current   | Any one input                                     | ±10                                      | mA   |
|                  |  | $T_{A} = -40^{\circ}C \text{ to } + 100^{\circ}C$ | 500                                      | mW   |
| PD               | D Power dissipation per package  | T <sub>A</sub> = 100°C to + 125°C                 | Derate linearly at<br>12 mW/°C to 200 mW |      |
|                  | Device dissipation per output tra<br>(for $T_A$ = full package-temperatu |   | 100                                      | mW   |
| T <sub>A</sub>   | Operating-temperature range  |   | -40 to +125                              | °C   |
| T <sub>stg</sub> | Storage temperature range  |   | -65 to +150                              | °C   |
|                  | Latch-Up Performance per JES   | D 78, Class I                                     | 50                                       | mA   |

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## **RECOMMENDED OPERATING CONDITIONS**

|                 |  | MIN | MAX | UNIT |
|-----------------|--|-----|-----|------|
| V <sub>DD</sub> | Supply-voltage range (for T <sub>A</sub> = full package-temperature range) | 3   | 18  | V    |

### STATIC ELECTRICAL CHARACTERISTICS

|                      |  | C            | ONDITIO         | NS              | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |                   |      | )    |
|----------------------|--|--------------|-----------------|-----------------|---------------------------------------|-------|-------|-------|-------------------|------|------|
|                      | PARAMETER                              | Vo           | V <sub>IN</sub> | V <sub>DD</sub> | -40                                   | +85   | +125  |       | +25               |      | UNIT |
|                      |  | (V)          | (V)             | (V)             |                                       | +05   |       | MIN   | TYP               | MAX  | 0    |
|                      |  |              | 0, 5            | 5               | 1                                     | 30    | 30    |       | 0.02              | 1    |      |
| I Mox                | Quiescent device current               |              | 0, 10           | 10              | 2                                     | 60    | 60    |       | 0.02              | 2    |      |
| I <sub>DD</sub> Max  | Quiescent device current               |              | 0, 15           | 15              | 4                                     | 120   | 120   |       | 0.02              | 4    | μA   |
|                      |  |              | 0, 20           | 20              | 20                                    | 600   | 600   |       | 0.04              | 20   |      |
|                      |  | 0.4          | 0, 5            | 5               | 0.61                                  | 0.42  | 0.36  | 0.51  | 1                 |      |      |
| I <sub>OL</sub> Min  | Output low (sink) current              | 0.5          | 0, 10           | 10              | 1.5                                   | 1.1   | 0.9   | 1.3   | 2.6               |      |      |
|                      |  | 1.5          | 0, 15           | 15              | 4                                     | 2.8   | 2.4   | 3.4   | 6.8               |      |      |
|                      |  | 4.6          | 0, 5            | 5               | -0.61                                 | -0.42 | -0.36 | -0.51 | -1                |      | mA   |
| 1 M.                 |  | 2.5          | 0, 5            | 5               | -1.8                                  | -1.3  | -1.15 | -1.6  | -3.2              |      |      |
| I <sub>OH</sub> Min  | Output high (source) current           | 9.5          | 0, 10           | 10              | -1.5                                  | -1.1  | -0.9  | -1.3  | -2.6              |      |      |
|                      |  | 13.5         | 0, 15           | 15              | -4                                    | -2.8  | -2.4  | -3.4  | -6.8              |      |      |
|                      |  |              | 0, 5            | 5               | 0.05                                  |       |       |       | 0                 | 0.05 |      |
| V <sub>OL</sub> Max  | Output voltage: low-level              |              | 0, 10           | 10              | 0.05                                  |       |       |       | 0                 | 0.05 |      |
|                      |  |              | 0, 15           | 15              |                                       | 0.05  |       |       | 0                 | 0.05 | .,   |
|                      |  |              | 0, 5            | 5               |                                       | 4.95  |       | 4.95  | 5                 |      | V    |
| V <sub>OH</sub> Min  | Output voltage: high-level             |              | 0, 10           | 10              |                                       | 9.95  |       | 9.95  | 10                |      |      |
|                      |  |              | 0, 15           | 15              |                                       | 14.95 |       | 14.95 | 15                |      |      |
| I <sub>IN</sub> Max  | Input current                          |              | 0, 18           | 18              | ±0.1                                  | ±1    | ±1    |       | ±10 <sup>-5</sup> | ±0.1 | μA   |
| I <sub>OUT</sub> Max |  |              | 0, 18           | 18              | ±0.4                                  | ±12   | ±12   |       | ±10 <sup>-4</sup> | ±0.4 | μA   |
|                      |  | 1, 9         | 5               | 10              |                                       | 1.5   |       |       |                   | 1.5  |      |
| V <sub>IL</sub> Max  | Input low voltage                      | 1.5,<br>13.5 | 10              | 15              |                                       | 3     |       |       |                   | 3    |      |
|                      |  | 1, 9         | 5               | 10              |                                       | 3.5   |       | 3.5   |                   |      | V    |
| V <sub>IH</sub> Min  | V <sub>IH</sub> Min Input high voltage |              | 10              | 15              | 7                                     |       | 7     |       |                   |      |      |

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# DYNAMIC ELECTRICAL CHARACTERISTICS

 $T_{A}$  = 25°C, Input t\_r/t\_f = 20 ns,  $C_{L}$  = 50 pF,  $R_{L}$  = 200 k $\Omega$  (unless otherwise noted)

|                                     | PARAMETER  | TEST CONDITIONS                     | SHIFTING MODE | V <sub>CC</sub><br>(V) | V <sub>DD</sub><br>(V) | MIN | МАХ | UNIT    |    |   |     |     |  |
|-------------------------------------|--|-------------------------------------|---------------|------------------------|------------------------|-----|-----|---------|----|---|-----|-----|--|
|                                     |  |                                     |               | 5                      | 10                     | 300 | 600 |         |    |   |     |     |  |
|                                     |  |                                     | L–H           | 5                      | 15                     | 220 | 440 |         |    |   |     |     |  |
|                                     | Propagation delay time,                            |                                     |               | 10                     | 15                     | 180 | 360 |         |    |   |     |     |  |
| t <sub>PHL</sub>                    | high-to-low level, data input to output            |                                     |               | 10                     | 5                      | 250 | 500 | ns      |    |   |     |     |  |
|                                     |  |                                     | H – L         | 15                     | 5                      | 250 | 500 |         |    |   |     |     |  |
|                                     |  |                                     |               | 15                     | 10                     | 120 | 240 |         |    |   |     |     |  |
|                                     |  |                                     |               | 5                      | 10                     | 130 | 260 |         |    |   |     |     |  |
|                                     |  |                                     | L–H           | 5                      | 15                     | 120 | 240 |         |    |   |     |     |  |
|                                     | Propagation delay time,                            |                                     |               | 10                     | 15                     | 70  | 140 | 20      |    |   |     |     |  |
| t <sub>PLH</sub>                    | low-to-high level, data<br>input to output         |                                     |               | 10                     | 5                      | 230 | 460 | ns      |    |   |     |     |  |
|                                     |  |                                     | H – L         | 15                     | 5                      | 230 | 460 |         |    |   |     |     |  |
|                                     |  |                                     |               | 15                     | 10                     | 80  | 160 |         |    |   |     |     |  |
|                                     |  |                                     |               | 5                      | 10                     | 60  | 120 |         |    |   |     |     |  |
|                                     | Drene netice deleviting                            |                                     | L – H         | 5                      | 15                     | 75  | 150 |         |    |   |     |     |  |
|                                     | Propagation delay time,<br>3-state disable, delay, |                                     |               | 10                     | 15                     | 35  | 70  |         |    |   |     |     |  |
| t <sub>PHZ</sub>                    | PHZ output high to high                            | butput high to high $R_L = 1 R_{M}$ |               | 10                     | 5                      | 200 | 400 | ns      |    |   |     |     |  |
| impedance                           | nce  | H – L                               | 15            | 5                      | 200                    | 400 |     |         |    |   |     |     |  |
|                                     |  |                                     | 15            | 10                     | 40                     | 80  |     |         |    |   |     |     |  |
|                                     |  |                                     | 5             | 10                     | 370                    | 740 |     |         |    |   |     |     |  |
|                                     | Deserve data data di data di serve                 |                                     | L – H         | 5                      | 15                     | 300 | 600 | ns      |    |   |     |     |  |
|                                     | Propagation delay time,<br>3-state disable, delay, |                                     |               | 10                     | 15                     | 250 | 500 |         |    |   |     |     |  |
| t <sub>PLZ</sub>                    | output low to high                                 | $R_L = 1 k\Omega$                   |               | 10                     | 5                      | 250 | 500 |         |    |   |     |     |  |
|                                     | impedance  |                                     | H – L         | 15                     | 5                      | 250 | 500 |         |    |   |     |     |  |
|                                     |  |                                     |               | 15                     | 10                     | 130 | 260 |         |    |   |     |     |  |
|                                     |  |                                     |               | 5                      | 10                     | 320 | 640 | ns      |    |   |     |     |  |
|                                     | Drene netice deleviting                            |                                     | L–H           | 5                      | 15                     | 230 | 460 |         |    |   |     |     |  |
|                                     | Propagation delay time,<br>3-state disable, delay, |                                     |               | 10                     | 15                     | 180 | 360 |         |    |   |     |     |  |
| t <sub>PZH</sub>                    | output high impedance                              | $R_L = 1 k\Omega$                   |               | 10                     | 5                      | 300 | 600 |         |    |   |     |     |  |
|                                     | to high  |                                     |               |                        |                        |     |     | H – L   | 15 | 5 | 300 | 600 |  |
|                                     |  |                                     |               | 15                     | 10                     | 130 | 260 |         |    |   |     |     |  |
|                                     |  |                                     |               | 5                      | 10                     | 100 | 200 |         |    |   |     |     |  |
|                                     | Descention delay the                               |                                     | L – H         | 5                      | 15                     | 80  | 160 |         |    |   |     |     |  |
|                                     | Propagation delay time, 3-state disable, delay,    |                                     |               | 10                     | 15                     | 40  | 80  |         |    |   |     |     |  |
| t <sub>PZL</sub>                    | output high impedance                              | $R_L = 1 k\Omega$                   |               | 10                     | 5                      | 200 | 400 | ns      |    |   |     |     |  |
|                                     | to low   |                                     | H – L         | 15                     | 5                      | 200 | 400 |         |    |   |     |     |  |
|                                     |  |                                     |               | 15                     | 10                     | 40  | 80  | 1       |    |   |     |     |  |
|                                     |  |                                     |               | 5                      | 10                     | 50  | 100 |         |    |   |     |     |  |
|                                     |  |                                     | L – H         | 5                      | 15                     | 40  | 80  | -<br>ns |    |   |     |     |  |
|                                     | <b>—</b> 10 0                                      |                                     |               | 10                     | 15                     | 40  | 80  |         |    |   |     |     |  |
| t <sub>THL</sub> , t <sub>TLH</sub> | Transition time                                    |                                     |               | 10                     | 5                      | 100 | 200 |         |    |   |     |     |  |
|                                     |  |                                     | H – L         | 15                     | 5                      | 100 | 200 |         |    |   |     |     |  |
|                                     |  |                                     |               | 15                     | 10                     | 50  | 100 |         |    |   |     |     |  |
| C <sub>i</sub>                      | Input capacitance                                  |                                     |               | Anv                    | input                  | 5   | 7.5 | pF      |    |   |     |     |  |



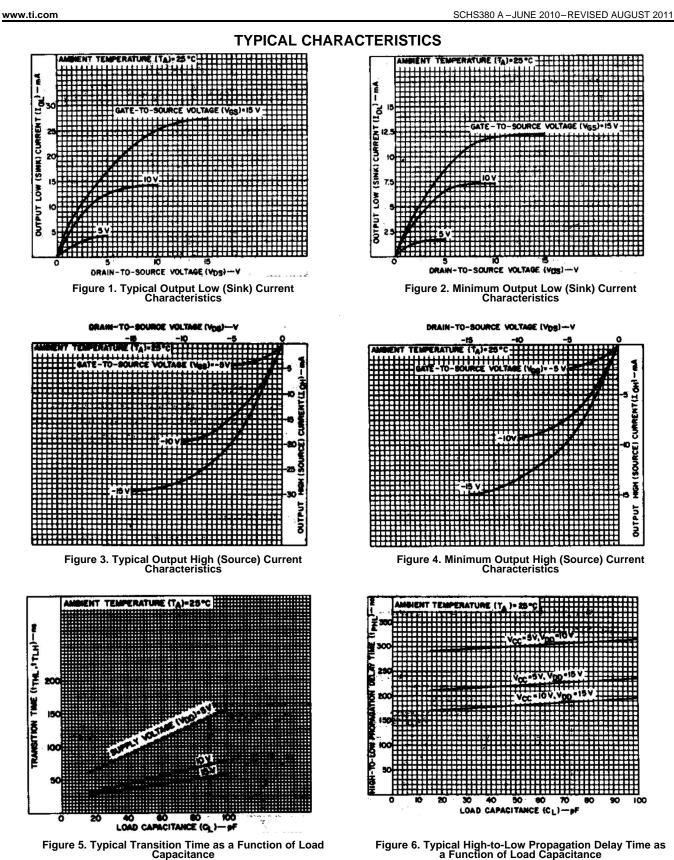
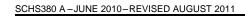


Figure 6. Typical High-to-Low Propagation Delay Time as a Function of Load Capacitance

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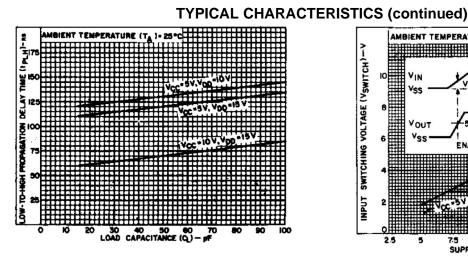


Figure 7. Typical Low-to-High Propagation Delay Time as a Function of Load Capacitance

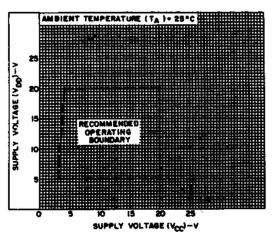


Figure 9. High-Level Supply Voltage vs Low-Level Supply Voltage

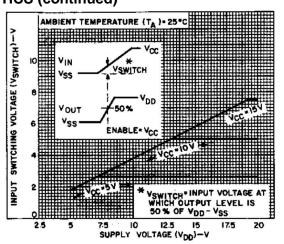


Figure 8. Typical Input Switching as a Function of High-Level Supply Voltage

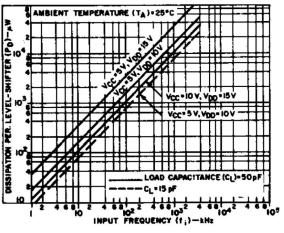


Figure 10. Typical Dynamic Power Dissipation as a Function of Input Frequency



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### PARAMETER MEASUREMENT INFORMATION

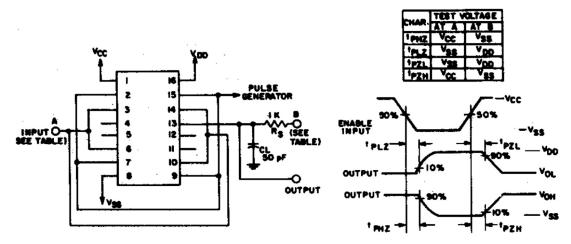


Figure 11. Output Enable Delay Times Test Circuit and Waveforms

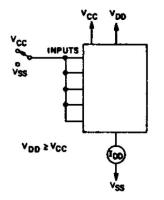


Figure 12. Quiescent Device Current Test Circuit

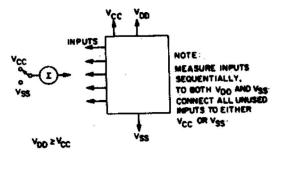
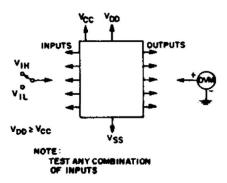


Figure 14. Input Current Test Circuit





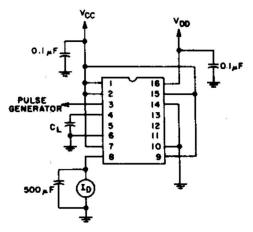
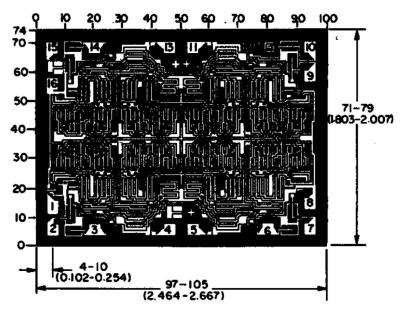


Figure 15. Dynamic Power Dissipation Test Circuit



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Note: Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \text{ inch})$ .

Figure 16. Dimensions and Pad Layout



### PACKAGING INFORMATION

| Orderable part number | Status<br>(1) | Material type (2) | Package   Pins | Package qty   Carrier | <b>RoHS</b><br>(3) | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|-------------------|----------------|-----------------------|--------------------|-------------------------------|----------------------------|--------------|------------------|
|                       |               |                   |                |                       |                    | (4)                           | (5)                        |              |                  |
| CD40109BQNSRQ1        | Active        | Production        | SOP (NS)   16  | 2000   LARGE T&R      | Yes                | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 125   | CD40109BQ        |
| CD40109BQNSRQ1.A      | Active        | Production        | SOP (NS)   16  | 2000   LARGE T&R      | Yes                | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 125   | CD40109BQ        |

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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#### OTHER QUALIFIED VERSIONS OF CD40109B-Q1 :

Catalog : CD40109B



23-May-2025

• Military : CD40109B-MIL

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications



## TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| CD40109BQNSRQ1              | SOP             | NS                 | 16 | 2000 | 330.0                    | 16.4                     | 8.1        | 10.4       | 2.5        | 12.0       | 16.0      | Q1               |



# PACKAGE MATERIALS INFORMATION

13-May-2025



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD40109BQNSRQ1 | SOP          | NS              | 16   | 2000 | 356.0       | 356.0      | 35.0        |

# MECHANICAL DATA

## PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# **NS0016A**



# **PACKAGE OUTLINE**

SOP - 2.00 mm max height

SOP



#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- Per ASME Y14.5M.
   This drawing is subject to change without notice.
   This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



# NS0016A

# **EXAMPLE BOARD LAYOUT**

# SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# NS0016A

# **EXAMPLE STENCIL DESIGN**

# SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



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